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GAAS MMIC SP8T NON-REFLECTIVE SWITCH, DC - 2.5 GHz

Typical Applications

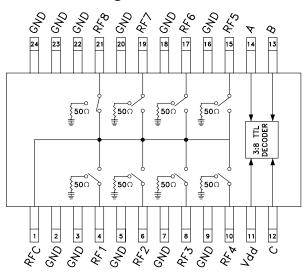
The HMC253AQS24 / HMC253AQS24E is ideal for DC - 2.5 GHz applications:

- CATV/DBS
- CDMA
- Cellular/PCS

Features

Low Insertion Loss (2 GHz): 1.1dB Single Positive Supply: Vdd = +5V Integrated 3:8 TTL Decoder 24 Lead QSOP Package

Functional Diagram



General Description

The HMC253AQS24 & HMC253AQS24E are low-cost non-reflective SP8T switches in 24-lead QSOP packages featuring wideband operation from DC to 2.5 GHz. The switch offers a single positive bias and true TTL/CMOS compatibility. A 3:8 decoder is integrated on the switch requiring only 3 control lines and a positive bias to select each path. The HMC253AQS24 & HMC253AQS24E SP8T will replace multiple configurations of SP4T and SPDT MMIC switches.

Electrical Specifications,

 $T_{A} = +25^{\circ}$ C, For TTL Control and Vdd = +5V in a 50 Ohm system

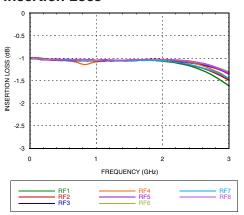
Parameter		Frequency	Min.	Тур.	Max.	Units
Insertion Loss		DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz		1.0 1.1 1.4	1.5 1.7 2.1	dB dB dB
Isolation		DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz	35 30 28	40 35 33		dB dB dB
Return Loss	"On State"	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz		21 20 16		dB dB dB
Return Loss (RF1-8)	"Off State"	0.3 - 2.5 GHz 0.5 - 2.5 GHz		8 13		dB dB
Input Power for 1 dB Compression		0.3 - 2.5 GHz	20	23		dBm
Input Third Order Intercept (Two-Tone Input Power = +10 dBm Each Tone)		0.3 - 2.5 GHz	41	46		dBm
Switching Characteristics		0.3 - 2.5 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)				20 90		ns ns



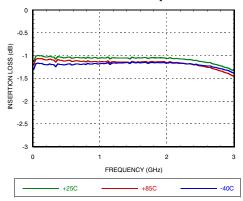
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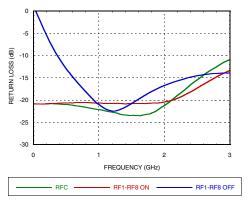
Insertion Loss



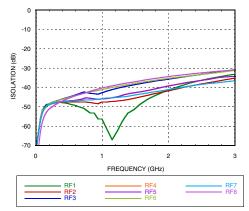
Insertion Loss vs. Temperature



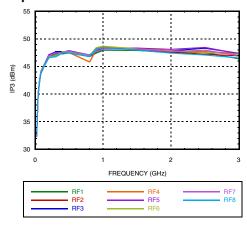
Return Loss



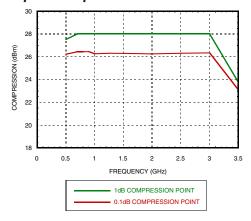
Isolation



Input IP3



Input Compression





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Bias Voltage & Current

Vdd Range = +5 Vdc ± 10%				
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)		
+5	4.5	7.5		

TTL/CMOS Control Voltages

State	Bias Condition		
Low	0 to +0.8 Vdc @ <1 μA Typ.		
High	+2.0 to +5 Vdc @ 60 μA Typ.		

Truth Table

Control Input			Signal Path State		
А	В	С	RFCOM to:		
Low	Low	Low	RF1		
High	Low	Low	RF2		
Low	High	Low	RF3		
High	High	Low	RF4		
Low	Low	High	RF5		
High	Low	High	RF6		
Low	High	High	RF7		
High	High	High	RF8		

NOTE:

DC Blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Absolute Maximum Ratings

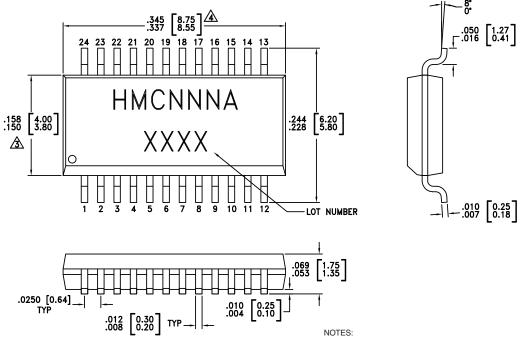
Bias Voltage Range (Port Vdd)	+7.0 Vdc		
	-0.5V to Vdd +1Vdc		
Control Voltage Range (A, B, C)	-0.5V to Vaa +1Vac		
Channel Temperature	150 °C		
Thermal Resistance			
(channel to package ground paddle)			
Through Path	183 °C/W		
Termination Path	274 °C/W		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		
Maximum Input Power			
(Vdd = +5V)			
Through Path	+20 dBm (0.05 - 0.5 GHz)		
	+25 dBm (0.5 - 2.5 GHz)		
Terminated Path	+20 dBm (0.05 - 0.5 GHz)		
	+23.5 dBm (0.5 - 2.5 GHz)		
ESD Sensitivity (HBM)	Class 1A		



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Outline Drawing



- LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Leadframe Plating	MSL Rating	Package Marking [3]
HMC253AQS24	Low Stress Injection Molded Plastic Silica and Silicon Impregnated	Sn/Pb Solder	MSL1 [1]	HMC253A XXXX
HMC253AQS24E	RoHS-compliant Low Stress Injection Molded Plastic Silica and Silicon Impregnated		MSL1 [2]	HMC253A XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX